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## DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated  
below next to my name.

I believe I am the original, first and joint inventor of the subject  
matter which is claimed and for which a patent is sought on the  
invention entitled: Methods of Forming an Isolation Trench in a  
Semiconductor, Methods of Forming an Isolation Trench in a Surface of  
a Silicon Wafer, Methods of Forming an Isolation Trench-Isolated  
Transistor, Trench-Isolated Transistor, Trench Isolation Structures Formed  
in a Semiconductor, Memory Cells and DRAMS, United States Patent  
Application Serial No. 09/652,550, filed August 31, 2000.

I hereby state that I have reviewed and understand the contents  
of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be  
material to patentability as defined in Title 37, Code of Federal  
Regulations §1.56.

### **PRIOR FOREIGN APPLICATIONS:**

I hereby state that no applications for foreign patents or inventor's  
certificates have been filed prior to the date of execution of this  
declaration.

I hereby declare that all statements made herein of my own  
knowledge are true and that all statements made on information and

1 belief are believed to be true; and further that these statements were  
2 made with the knowledge that willful false statements and the like so  
3 made are punishable by fine or imprisonment, or both, under  
4 Section 1001 of Title 18 of the United States Code and that such willful  
5 false statement may jeopardize the validity of the application or any  
6 patent issued therefrom.

7 \* \* \* \* \*

8 Full name of inventor: **KEIJI JONO**

9 Inventor's Signature: Keiji Jono

10 Date: 10-31-2000

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16 Full name of inventor: **HIROKAZU UEDA**

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2 Full name of inventor: **HIROYUKI WATANABE**

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